



Product presentation TRAVEO™ T2G CYT6BJ series

Q1 FY2026



Table of contents

1	Value proposition and customer value	3
2	Our offering to help customers to stay ahead	7
3	Where to get more information to get started	21

Table of contents

1	Value proposition and customer value	3
2	Our offering to help customers to stay ahead	7
3	Where to get more information to get started	21

How [TRAVEO™ T2G Body] brings value to the target applications/use cases?

Zone Control unit



Zone control unit

- 2.7 to 5.5 V power supply
- Ethernet
- Low power consumption
- Security
- FOTA

- Gigabit Ethernet, 10BASE-T1S
- Active 800 mA (Max), DeepSleep 50 uA (Typ)
- ISO 21434 compliance
- Dual bank Flash memory

Gateway



Telematics gateway

- 2.7 to 5.5 V power supply
- Quad Arm® Cortex® -M7 performance
- Ethernet, CAN FD, LIN
- Security
- FOTA

- 2,700 DMIPS
- Gigabit Ethernet, 10BASE-T1S, CAN FD
- ISO 21434 compliance
- Dual bank Flash memory

Infotainment



Infotainment

- 3.3 V power supply
- CAN FD communication
- Low power consumption
- Security
- FOTA

- CAN FD
- Active 800 mA (Max), DeepSleep 50 uA (Typ)
- ISO 21434 compliance
- Dual bank Flash memory

What are the market and technology trends in the target markets to help you stay ahead?



Ethernet

- Up to one gigabit Ethernet communication
- 10 BASE-T1S support
- Ethernet AVB



FOTA

- High speed programming and erasing
- Flash in dual bank mode
- Flash memory retention
- Security for the protection



CyberSecurity

- Secure boot
- eVita full HSM
- ISO 21434 compliance
- Diagnostics via OBD

What are the market and technology trends in the target markets to help you stay ahead?

FOTA

- High speed programming and erasing
- Flash in dual bank mode
- Flash memory retention
- Security for the protection

Ethernet

- Gigabit Ethernet
- 10BASE-T1S
- Ethernet AVB

CyberSecurity

- Secure boot
- eVita full HSM
- ISO 21434 compliance
- Diagnostics via OBD

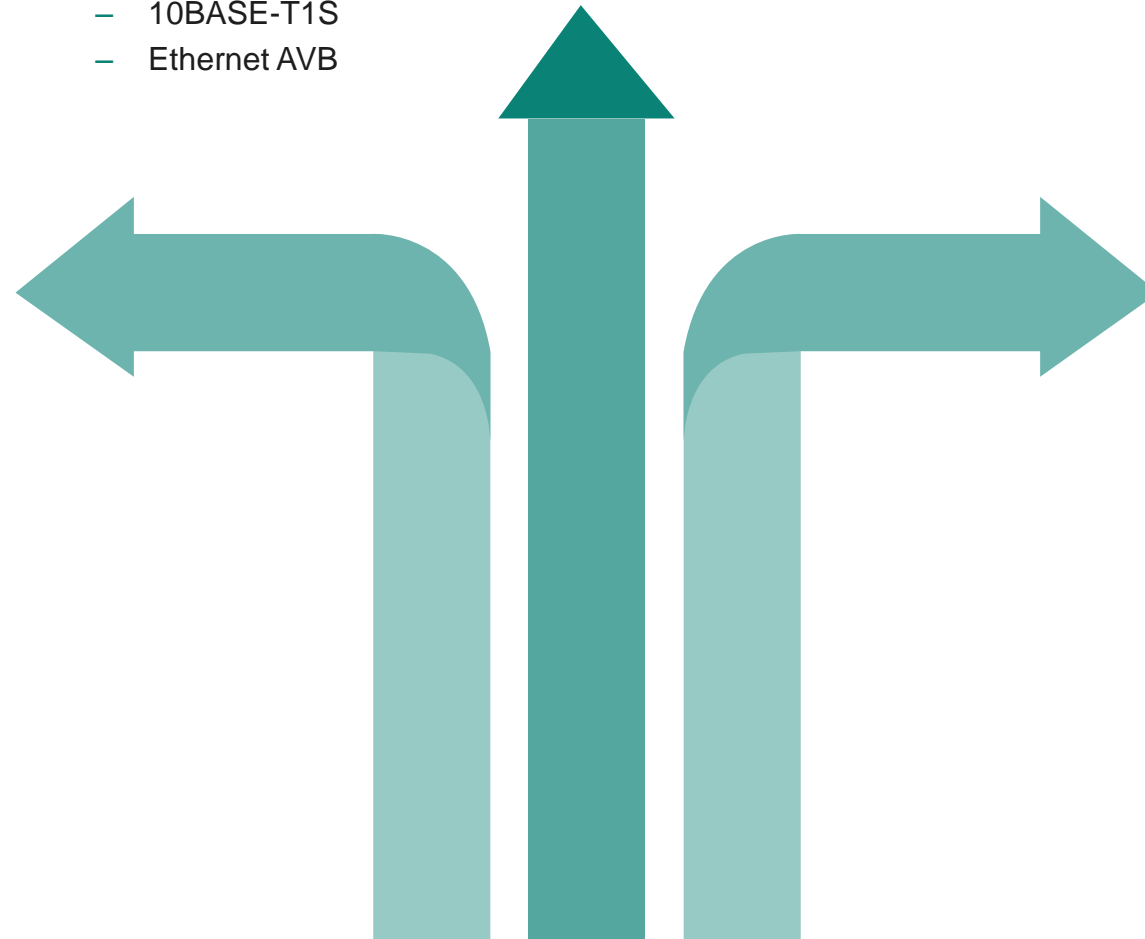


Table of contents

1	Value proposition and customer value	3
2	Our offering to help customers to stay ahead	7
	Product benefits in the context of the market/application trends	
	Infineon's product family positioning	
	Product one-pager overviews	
	Product portfolio table – differentiation of product variants	
	Kits/boards overview	
3	Where to get more information to get started	21

How [TRAVEO™ T2G Body] addresses the challenges in [Zone control]?

Key requirements in application

1. Gateway Functions of Zone Control
2. Power Distribution and Actuation functions of Zone Control
3. High-Efficiency Power Management
4. Cybersecurity & Functional Safety
5. Cover multiple applications, including Body Zone Control, I/O Aggregators and End nodes such as sensors and actuators



Typical challenges

1. Network management for multiple network interfaces
 - Multiple types of network interfaces with security features integrated into the T2G Body
2. Control of power distribution, power load, sensors, and actuators
 - Control and facilitation of ON/OFF switch outputs, motor drives, smart/distributed sensors, and actuators via serial interfaces and flexible I/Os
3. High Power Dissipation in Zone Controller
 - Lower power consumption and wake-up handling
4. Data Protection against Attacks and Enhancing safety and Reliability
 - EVITA FULL HSM and ASIL-B support for Body Zone Controller
5. Various types of software used in Zonal E/E architecture
 - Wide package and performance scalability within a single one microcontroller family



Infineon solution features and benefits

1. Robust network interface for gateway functions
 - Up to 2x 1G Ethernet, up to 10 CAN, up to 20 LIN with Cybersecurity
2. Key Functions in T2G for Power Distribution and Actuation
 - A High number of serial interfaces and flexible I/Os including SPI, I²C, PWM, UART and SMART I/O
 - Multiple channels with high precision of ADCs
3. High-Efficiency Power Management
 - Abundant low power modes, low power consumption, and fast wake-up times.
4. Appropriate Cybersecurity & Functional Safety for Body Zone Control
 - Secure environment for cryptographic operations and key management
 - Supports applications up to ASIL-B level.
5. T2G Body lineup can accommodate a wide range of applications
 - CYT6BJ expands support for 16 MB and 2 MB memory in the T2G Body family

What is Infineon's [TRAVEO™ T2G Body] positioning? [Arm® Cortex® -M7, Flash up to 16 MB, Gigabit/10Base-T1S Ethernet]

TRAVEO™ T2G Body High

NEW

CYT6BJ

TQFP 100		
TQFP 144		
TQFP 176	CYT6BJ8DDBQ0AESGS*	CYT6BJ8DDBQ0AEEGS*
BGA 272	CYT6BJBDHBQ0BZSGS	CYT6BJBDHBQ0BZEGS
BGA 320	CYT6BJCDHBQ0BZSGS	CYT6BJCDHBQ0BZEGS

- Quad Arm® Cortex® -M7, 320 MHz
- Code Flash 16 MB
- SRAM 2 MB
- Packages: BGA 320, BGA 272, TQFP 176*
- Gigabit Ethernet and 10 BASE-T1S: up to 2 ch
- CAN FD: up to 10 ch

CYT4BF

CYT4BF8CEDQ0AESGS CYT4BF8CDDQ0AESGS	CYT4BF8CEDQ0AEEGS CYT4BF8CDDQ0AEEGS
CYT4BFBCJDQ0BZSGS CYT4BFBCHDQ0BZSGS	CYT4BFBCJDQ0BZEGS CYT4BFBCHDQ0BZEGS
CYT4BFCCJDQ0BZSGS CYT4BFCCJDQ0BZEGS	CYT4BFCCJDQ0BZSGS CYT4BFCCJDQ0BZEGS

- Dual Arm® Cortex® -M7, 350 MHz
- Code Flash 8 MB
- SRAM 1 MB
- Packages: BGA 320, BGA 272, TQFP 176
- Gigabit Ethernet and 10 BASE-T1S: up to 2 ch
- CAN FD: up to 10 ch

CYT3BB/CYT4BB

CYT3BB5CEBQ1AESGS CYT4BB5CEBQ1AESGS	CYT3BB5CEBQ1AEEGS CYT4BB5CEBQ1AEEGS
CYT3BB7CEBQ1AESGS CYT4BB7CEBQ1AESGS	CYT3BB7CEBQ1AEEGS CYT4BB7CEBQ1AEEGS
CYT3BB8CEBQ1AESGS CYT4BB8CEBQ1AESGS	CYT3BB8CEBQ1AEEGS CYT4BB8CEBQ1AEEGS
CYT3BBBCEBQ1BZSGS CYT4BBBCEBQ1BZSGS	CYT3BBBCEBQ1BZEGS CYT4BBBCEBQ1BZEGS

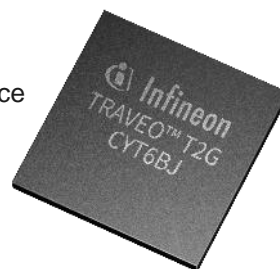
- Single/Dual Arm® Cortex® -M7, 250 MHz
- Code Flash 4 MB
- SRAM 768 KB
- Packages: BGA 272, TQFP 176, TQFP-144, TQFP-100
- 100 Mbps Ethernet and 10 BASE-T1S: 1 ch
- CAN FD: up to 8 ch

*Contact Sales

[TRAVEO™ T2G Body] CYT6BJ overview

Product highlights and benefits

- Quad Arm® Cortex®-M7, 320 MHz
- Code Flash: 16 MB, Work Flash: 512 KB, SRAM 2 MB
- ISO26262 ASIL -B Functional safety
- Embedded automotive security, EVITA full HSM, ISO 26262 compliance
- True FOTA support
- Gigabit Ethernet and 10BASE-T1S: up to 2 ch, CAN FD: 10 ch
- Most scalable portfolio in the market, package: BGA 320, BGA 272, TQFP 176*
- Low power consumption, DeepSleep 50 uA (typ)
- AUTOSAR 4.2 supported software
- Automotive quality and Business Continuity



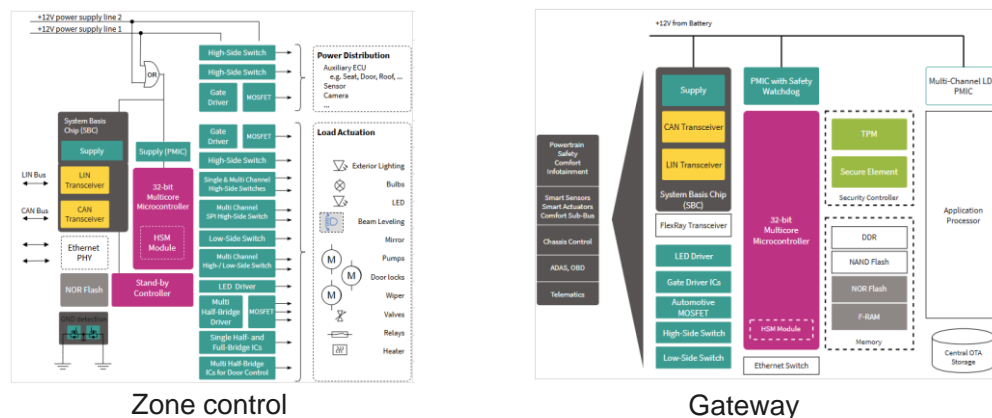
Key specifications

Part number	Packages	CPU	Code Flash/SRAM	Ethernet
CYT6BJCDHBQ0BZxGS	BGA 320	Quad Arm® Cortex®-M7	16 MB / 2 MB	2 ch
CYT6BJBDHBQ0BZxGS	BGA 272	Quad Arm® Cortex®-M7	16 MB / 2 MB	2 ch
CYT6BJ8DDBQ0AExGS*	TQFP 176*	Quad Arm® Cortex®-M7	16 MB / 2 MB	1 ch

Typical applications

- Zone control
- Body domain control
- Gateway
- Cockpit domain

Typical connection diagram/application diagram



Product information

- [TRAVEO™ T2G CYT6BJ series web page](#)
- [TRAVEO™ T2G CYT6BJ series Datasheet](#)
- [CYT6BJ series Evaluation board](#)

*Contact Sales

Key features TRAVEO™ T2G Body



¹ eSHE: enhanced secure hardware extension

² HSM: Hardware security module

³ FOTA: Firmware update over-the-air

⁴ RWW: Read while write

⁵ Embedded multimedia card

Low-power

- Energy-efficient processing power
- Deep Sleep: 50 uA (typ)

Performance

- Quad Arm® Cortex® -M7F
- Double precision FPU
- 2700 DMIPS

Scalability

- Complete portfolio with pin to pin compatibility
- Memory density
- Package lineup and performance

Safety

- ISO 26262 ASIL-B
- Safety Manual and FMEDA

Audio

- I²S/TDM
- High resolution 96 kHz

Security

- Hardware security module: eSHE¹, HSM²
- Evita full
- ISO21434 compliance

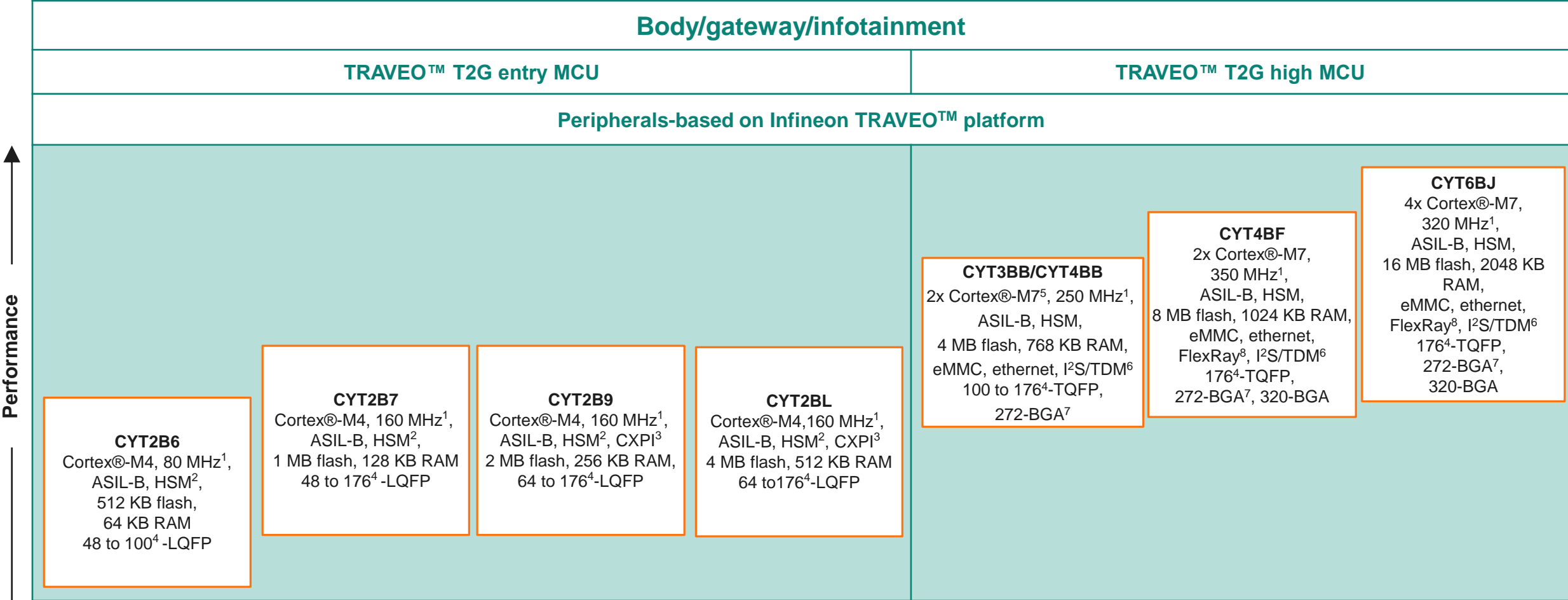
Connectivity

- LIN, CXPI
- CAN FD
- 1 Gb ethernet, 10BASE-T1S, Ethernet AVB

Updatability

- FOTA³ with RWW⁴ flash
- eMMC⁵
- QSPI/HS-SPI

TRAVEO™ T2G body MCU portfolio

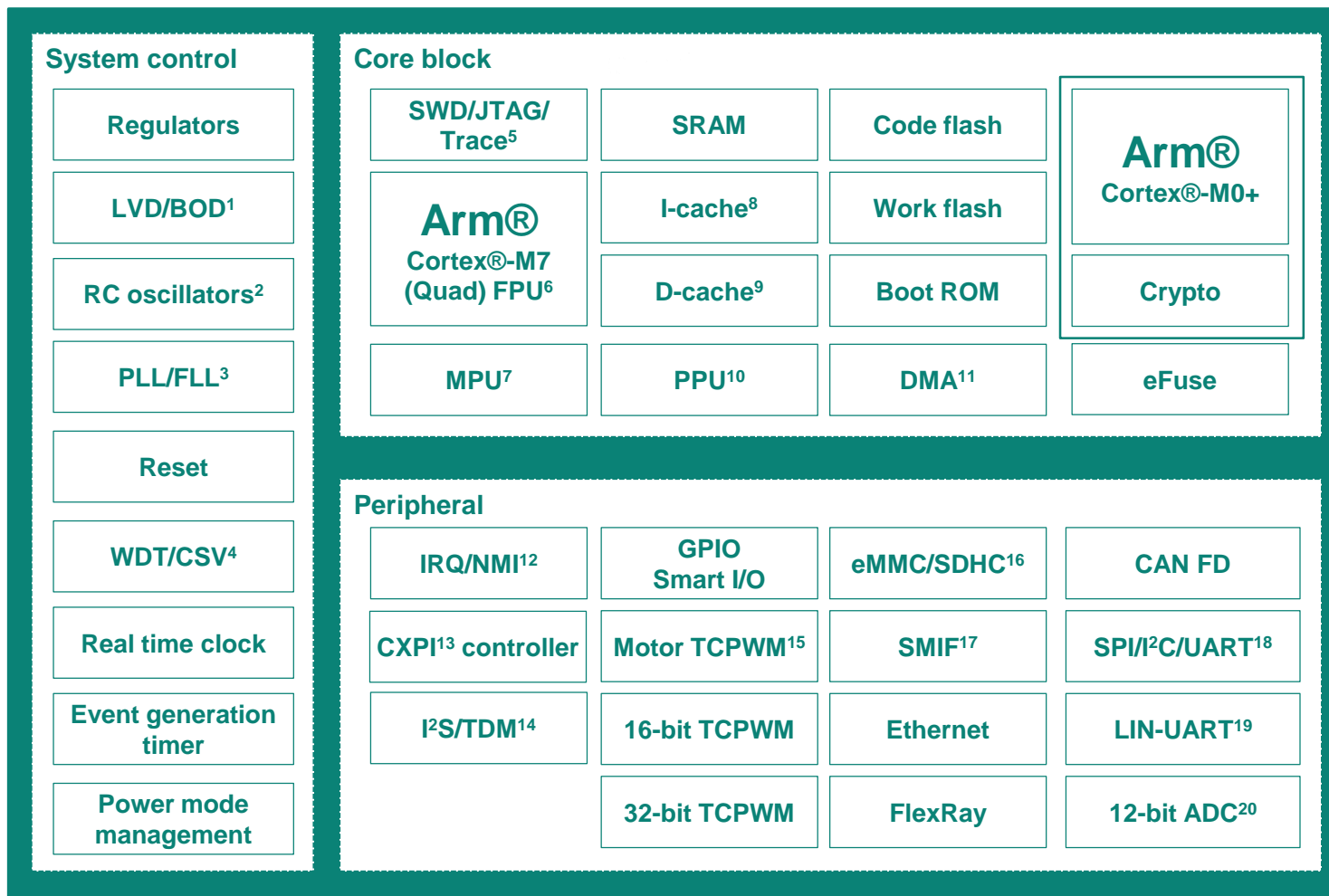


¹ Maximum operating frequency
² Hardware security module, SHE-only mode available
³ Clock eXtension peripheral interface
⁴ Package pin count, on request for 48 pin

⁵ Single or dual core option
⁶ Time division multiplexing
⁷ Fine pitch ball grid array
⁸ Optional feature

Status Sampling Production

TRAVEO™ T2G body feature overview



- ¹ Low-voltage detection/brownout detection
- ² Resistor capacitor
- ³ Phase-locked loop/frequency-locked loop
- ⁴ Watchdog timer/clock supervisor
- ⁵ Serial wire debug/Joint test action group
- ⁶ Floating point unit
- ⁷ Memory protection unit
- ⁸ Instruction cache
- ⁹ Data cache
- ¹⁰ Peripheral protection unit
- ¹¹ Direct memory access
- ¹² Interrupt request/Non-maskable interrupt
- ¹³ Clock extension peripheral
- ¹⁴ Inter-IC sound/time division multiplexed
- ¹⁵ Timer/counter/pulse-width modulation
- ¹⁶ Embedded Multi-Media Card/Secure Digital High Capacity
- ¹⁷ Serial memory interface
- ¹⁸ Serial peripheral interface/Inter-integrated circuit/universal asynchronous receiver transmitter
- ¹⁹ Local Interconnect Network - Universal asynchronous receiver transmitter
- ²⁰ Analog-to-digital converter

TRAVEO™ T2G CYT6BJ series

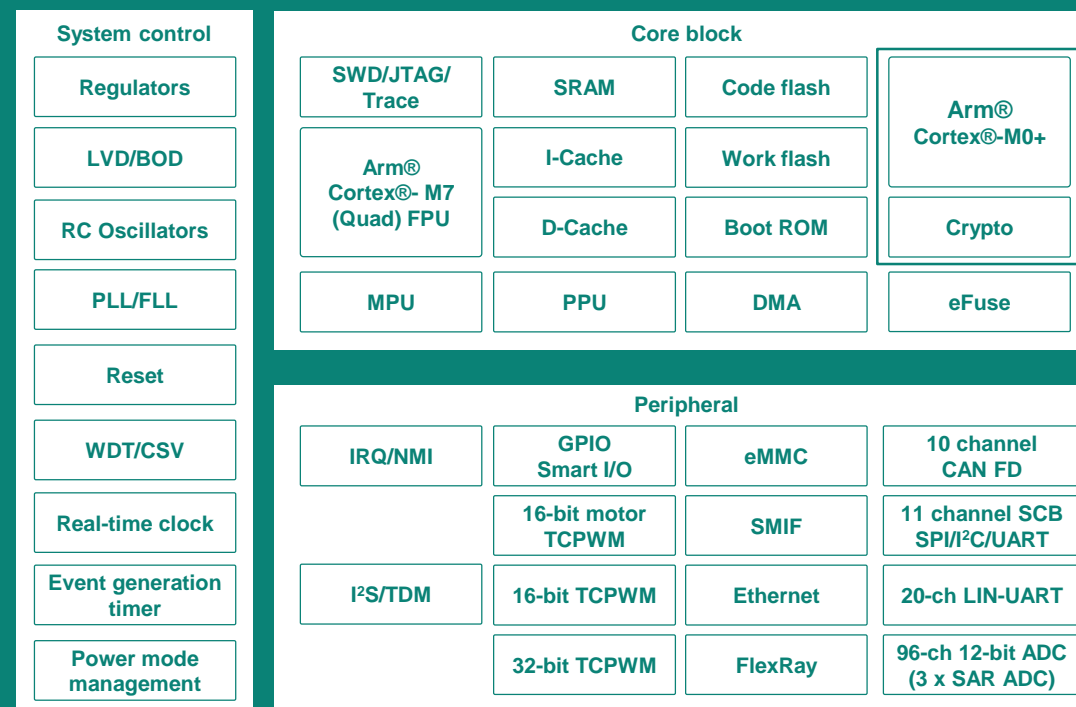
Applications

Body control module (BCM), gateway, and infotainment

Features

- **32-bit MCU core systems**
 - 320 MHz Arm® Cortex®-M7 Quad, I/D-cache
 - 16 MB flash, 512 KB work flash, 2048 KB SRAM, and Cortex®-M0+ for crypto
- **2.7 V to 5.5V supply voltages**
- **Interfaces**
 - Up to 10 channel CAN FD, up to 11 channel SCB, and 20 channel LIN-UART
 - eMMC, SMIF (QSPI/HS-SPI), up to 2 channel 10/100/1000-Mbit ethernet and FlexRay
 - I²S/TDM with TX 3 channel and RX 3 channel
- **AD converter**
 - Up to 96 channel, 12-bit with 3x successive approximation ADC (SAR ADC) units
- **Timers**
 - Up to 12 channel motor control, 87 channel 16-bit timer/counter/pulse-width modulation (TCPWM), and 16 channel 32-bit TCPWM
 - Event generation timer
- **High-speed I/O at 3.3 V in BGA**
 - Second operation voltage required for 3.3 V I/O
- **Packages**
 - 176-TQFP*, 272-BGA, 320-BGA
- **ISO 21434**
 - Compliance

CYT6BJ series



*Contact Sales

[TRAVEO™ T2G Body High CYT6BJ] portfolio – differentiation of product variants

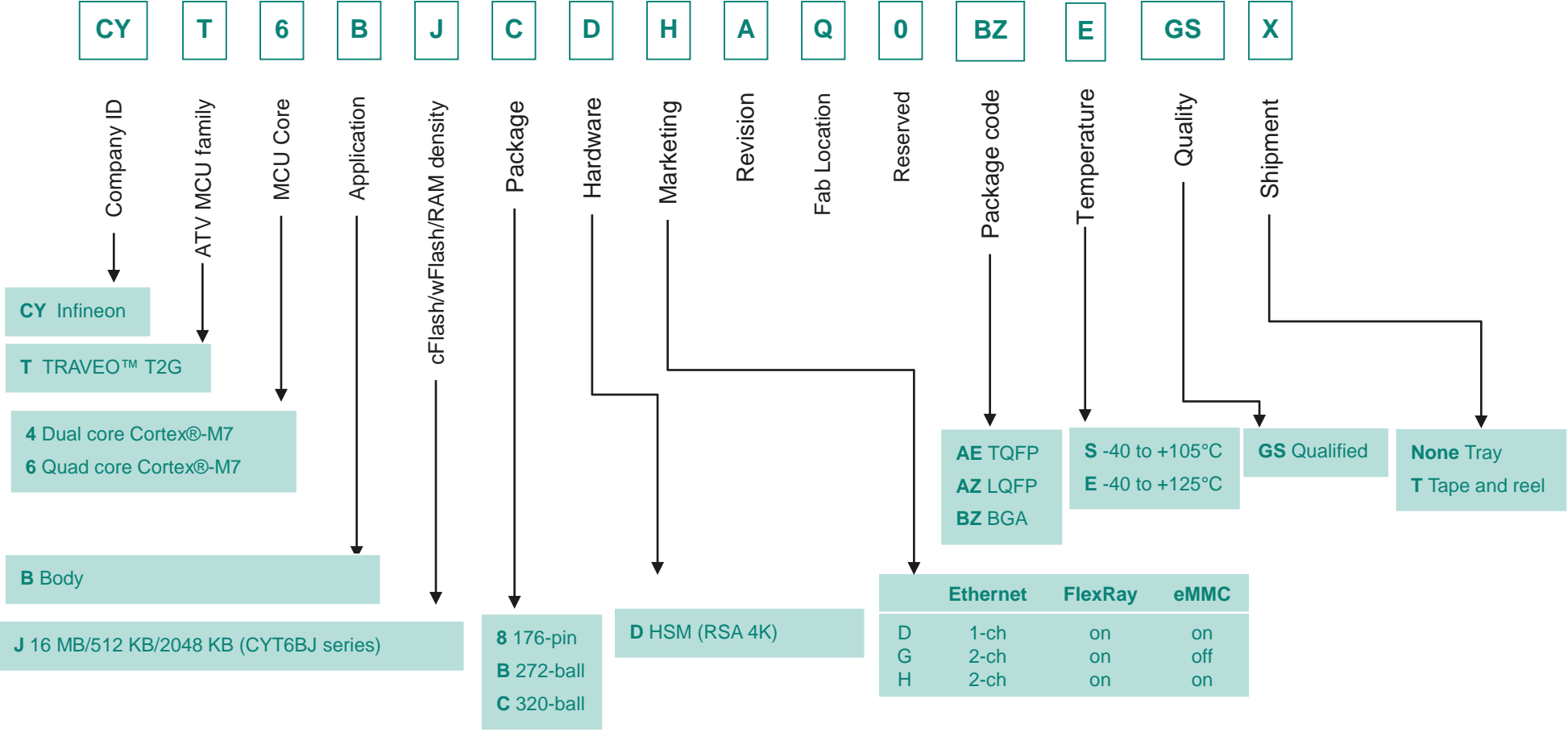


Specifications	CYT6BJCDHBQ0BZxGS	CYT6BJBDHBQ0BZxGS	CYT6BJ8DDBQ0AExGS*
Technology	CMOS 40 nm	CMOS 40 nm	CMOS 40 nm
Supply voltage	2.7 V to 5.5V	2.7 V to 5.5V	2.7 V to 5.5V
Package	BGA 320	BGA 272	TQFP 176
CPU (Arm Cortex-M7 cores)	4	4	4
Code Flash	16,768 KB	16,768 KB	16,768 KB
Work Flash	512 KB	512 KB	512 KB
SRAM	2,048 KB	2,048 KB	2,048 KB
A/D converter	3 units, 96 ch	3 units, 96 ch	3 units, 77 ch
Serial Communication (SCB)	11 ch	11 ch	10 ch
LIN communication	20 ch	20 ch	17 ch
CAN FD communication	10 ch	10 ch	10 ch
Ethernet	2 ch (10/100/1000 Mbps)	2 ch (10/100/1000 Mbps)	1 ch (10/100 Mbps)
TCPWM timer	16 bit x 87 ch 32 bit x 16 ch	16 bit x 87 ch 32 bit x 16 ch	16 bit x 87 ch 32 bit x 16 ch
Temperature grade	Ta = -40 to +105C/+125C	Ta = -40 to +105C/+125C	Ta = -40 to +105C/+125C

Supported shipment types are “Tray” (default) and “Tape and Reel”. Add the character ‘T’ at the end to get the ordering code for “Tape and Reel” shipment type.

*Contact Sales

Product naming nomenclature



Kits/boards overview

TRAVEO™ T2G B-H-16M 320 CPU Evaluation Board

Key features.

- TRAVEO™ T2G CYT6BJ device (MCU) embedded.
- Supports up to 10 CAN FD channels
- Up to 20 independent LIN channels
- Two 10/100/1000 Mbps Ethernet MAC interfaces
- 64 Mbit HYPERRAM™ DRAM memory (S27KL) and 512 Mbit SEMPER™ octal flash memory (S26HL), 512 Mbit Dual QSPI NOR flash (S25HL)
- A mini-B type connector for an USB device interface
- Four different program/debug interfaces



TRAVEO™ T2G B-H-16M 176 CPU Evaluation Board

Key features.

- TRAVEO™ T2G CYT6BJ device(MCU) embedded.
- Support up to 10 CAN FD channels.
- Up to 17 independent LIN channels.
- One 10/100 Mbps Ethernet MAC interface
- 64 Mbits HYPERRAM DRAM memory (S27KL) and 512 Mbit SEMPER octal flash memory (S26HL) , 512 Mbit Dual QSPI NOR flash (S25HL)
- A mini-B type connector for an USB device interface.
- Four different program/Debug interface.



TRAVEO™ T2G B-H-16M Lite kit*

Key features.

- TRAVEO™ T2G CYT6BJ device(MCU) embedded.
- Support up to 10 CAN FD channels.
- Up to 17 independent LIN channels.
- 10BASE-T1S interface form Multidrop Ethernet network
- Two 512 Mbit Dual QSPI NOR flash (S25HL)
- A USB type-C connector for an USB device interface.
- Onboard programmer/debugger - KitProg3.



*Contact Sales

Software offer

AUTOSAR

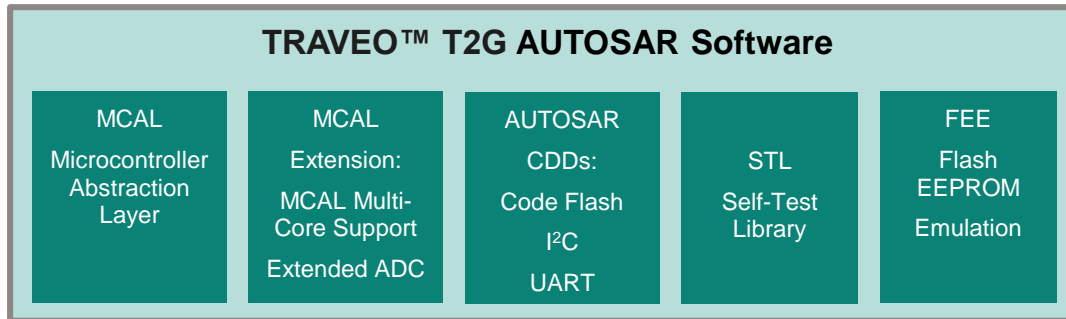
ISO 26262



- AUTOSAR version 4.2.2 compliant (T2G Body)
- Development process ISO26262 audited/certified by TÜV Süd
- Developed as safety element out of context (SEooC) for ASIL B

EB EB tresos Studio
29.7.5

- Functional safety documentation available
- Released for GHS compiler version 2024.1.4 + IAR EWARM FS 9.50.3
- EB tresos Studio v29.7.5 for TRAVEO™ included in delivery (node locked license)



✓ Automotive Qualified Software

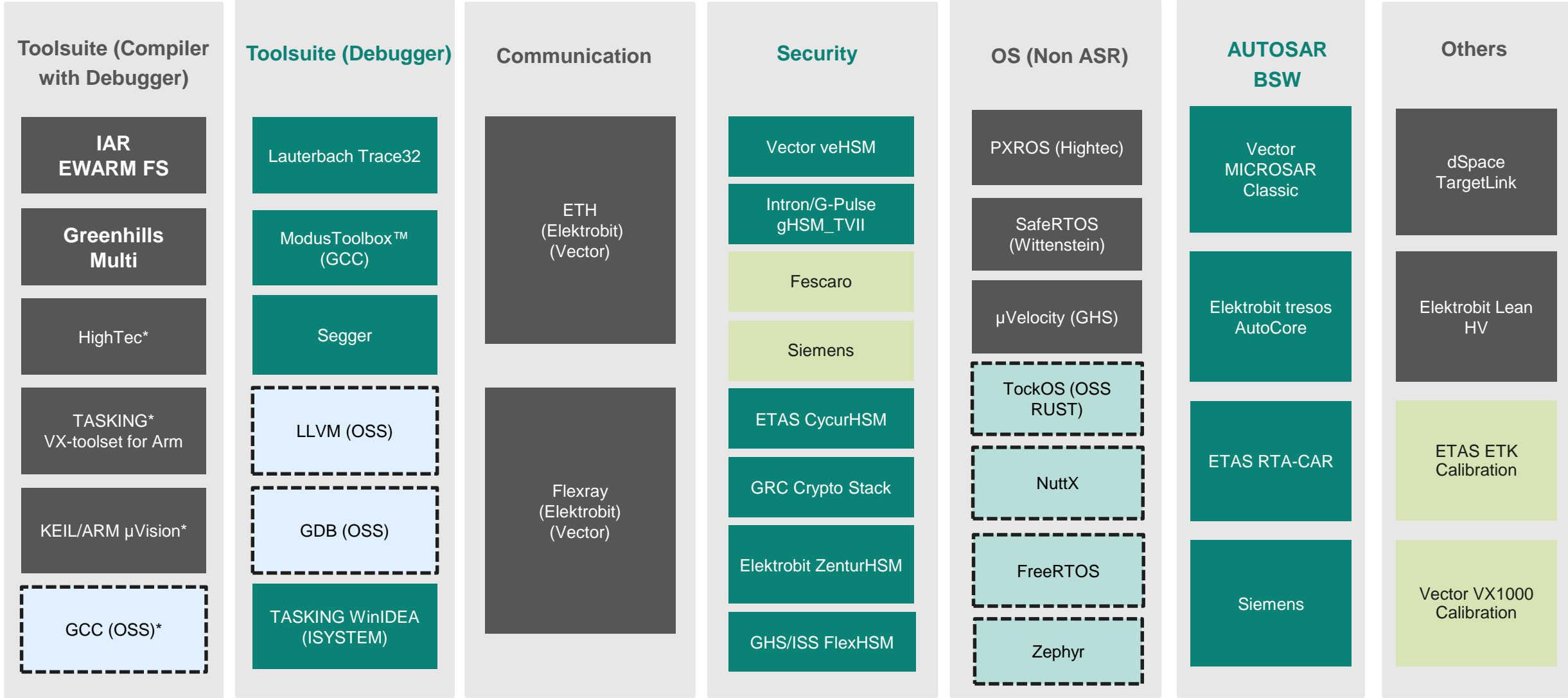
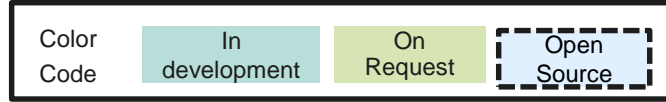
VECTOR >



Discover the Experience

ETAS

Ecosystem



ModusToolbox™ – ease of use

TRAVEO™ T2G Lite kits

KIT_T2G-B-H-16M_LITE

Fully supported by [ModusToolbox™](#)

ModusToolbox™

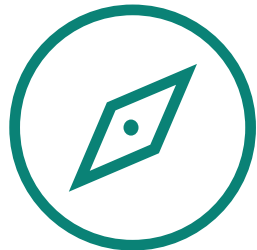
ModusToolbox™ Software is a modern, extensible development ecosystem supporting a wide range of Infineon microcontroller devices, including [PSOC™ Arm® Cortex® microcontrollers](#), [TRAVEO™ T2G Arm® Cortex® microcontroller](#). Provided as a collection of development tools, libraries, and embedded runtime assets, ModusToolbox™ Software is architected to provide a flexible and comprehensive development experience

- [User manual](#)
- [Getting started](#)
- [ModusToolbox™ product presentation](#)
- [GitHub](#)
- [Community support](#)

Table of contents

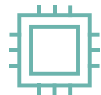
1	Value proposition and customer value	3
2	Our offering to help customers to stay ahead	7
3	Where to get more information to get started	21

Further resources



Product and application information

- [TRAVEO™ T2G Body Product family page](#)
- [Automotive body electronics & power distribution applications](#)



Reference designs & boards

- [Evaluation board](#) (Will available in Oct 2025)
- [TRAVEO™ T2G AUTOSAR Software](#)
- [TRAVEO™ Software & Tools](#)



Technical documents

- [Application note and Technical reference manual](#)
- [MCU Power Estimator](#)



Trainings

- [online trainings](#)



